

2A, 200V- 1000V Fast Recovery Surface Mount Rectifiers

FEATURES

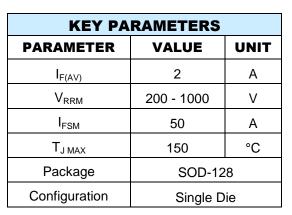
- Glass passivated junction chip
- Ideal for automated placement
- Low power loss, high efficiency
- Fast switching for high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

| ΔΡ | 10 | | \sim | ~ |
|----|----|---|--------|----------|
| | | 4 | | ~ |

- High frequency rectification
- Freewheeling application
- · Switching mode converters and inverters, computer and telecommunication.

| 845 | \sim 11 | | A I | D 4 | T A |
|------|-----------|----|-----|------------|------------|
| IVIE | CH. | AN | AL | DF | ATA |

- Case: SOD-128
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Pure tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.027 g (approximately)











SOD-128

| ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted) | | | | | | | | |
|---|--------------------------------|------------------|-------------|--------|--------|--------|--------|------|
| PARAMETER | | SYMBOL | RS2DFS | RS2GFS | RS2JFS | RS2KFS | RS2MFS | UNIT |
| Marking code on the devi | ice | | RS2DFS | RS2GFS | RS2JFS | RS2KFS | RS2MFS | |
| Repetitive peak reverse v | oltage/ | V_{RRM} | 200 | 400 | 600 | 800 | 1000 | V |
| Reverse voltage, total rms value | | $V_{R(RMS)}$ | 140 | 280 | 420 | 560 | 700 | V |
| Forward current | | I _F | 2 | | | | | Α |
| Surge peak forward current, single half sine- | | 1 | 50 | | | | | Α |
| wave superimposed on rated load per diode | 1.0ms at T _A = 25°C | I _{FSM} | 140 | | | | | А |
| Junction temperature | | T _J | -55 to +150 | | | | | °C |
| Storage temperature | | T _{STG} | -55 to +150 | | | | | °C |

1



| THERMAL PERFORMANCE | | | | | |
|--|------------------|-----|------|--|--|
| PARAMETER | SYMBOL | TYP | UNIT | | |
| Junction-to-lead thermal resistance | $R_{\Theta JL}$ | 16 | °C/W | | |
| Junction-to-ambient thermal resistance | $R_{\Theta JA}$ | 73 | °C/W | | |
| Junction-to-case thermal resistance | R _{eJC} | 14 | °C/W | | |

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

| PARAMET | ΓER | CONDITIONS | SYMBOL | TYP | MAX | UNIT |
|--|----------------------------|---|-----------------|------|------|------|
| | | I _F = 1.0A, T _J = 25°C | | 0.93 | - | V |
| | RS2DFS | $I_F = 2.0A, T_J = 25^{\circ}C$ | | 1.01 | 1.30 | V |
| | RS2GFS RS2JFS | I _F = 1.0A, T _J = 125°C | | 0.78 | - | V |
| Famuuand valtage (1) | | $I_F = 2.0A, T_J = 125^{\circ}C$ | | 0.88 | 1.02 | V |
| Forward voltage ⁽¹⁾ | | I _F = 1.0A, T _J = 25°C | V _F | 0.98 | - | V |
| | RS2KFS | $I_F = 2.0A, T_J = 25^{\circ}C$ | | 1.06 | 1.30 | V |
| | RS2MFS | I _F = 1.0A, T _J = 125°C | | 0.83 | - | V |
| | | I _F = 2.0A, T _J = 125°C | | 0.93 | 1.05 | V |
| 2 (2) | | T _J = 25°C | ı | - | 1 | μΑ |
| Reverse current @ rated V _R | | T _J = 125°C | l _R | - | 40 | μΑ |
| | RS2DFS RS2GFS | | t _{rr} | - | 150 | ns |
| Reverse recovery time | RS2JFS | I _F =0.5A,I _R =1.0A, Irr=0.25A | | - | 250 | ns |
| | RS2KFS RS2MFS | 0.20/ | | - | 500 | ns |
| Junction capacitance | RS2DFS RS2GFS RS2JFS | 1 MHz, V _R =4.0V | Сл | 11 | - | pF |
| · | RS2KFS RS2MFS | | | 10 | - | pF |

Notes:

- (1) Pulse test with PW=0.3 ms
- (2) Pulse test with PW=30 ms

| ORDERING INFORMATION | | | | | |
|------------------------------|---------|-------------------|--|--|--|
| ORDERING CODE ⁽¹⁾ | PACKAGE | PACKING | | | |
| RS2xFS M3G | SOD-128 | 3,500 / 7" reel | | | |
| RS2xFS M2G | SOD-128 | 14,000 / 13" reel | | | |

Notes:

(1) "x" defines voltage from 200V(RS2DFS) to 1000V(RS2MFS)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

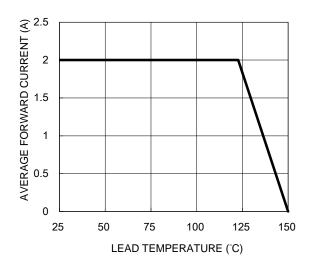


Fig.3 Typical Reverse Characteristics

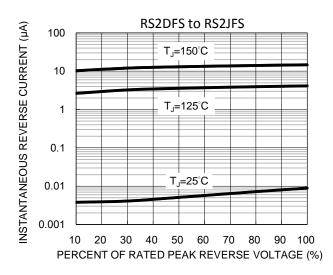


Fig.5 Typical Reverse Characteristics

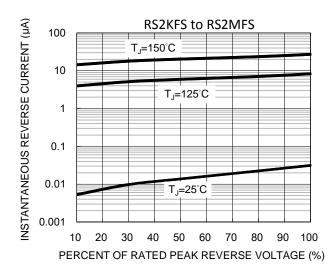


Fig.2 Typical Junction Capacitance

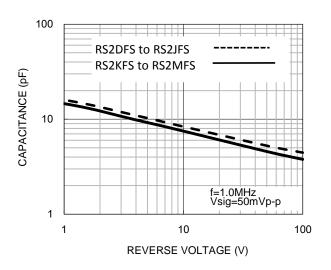


Fig.4 Typical Forward Characteristics

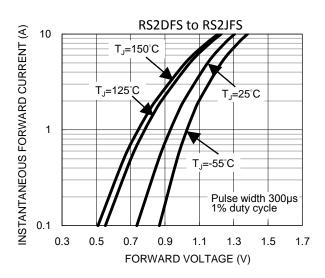
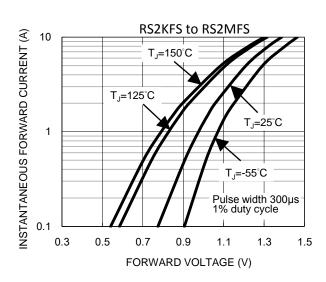


Fig.6 Typical Forward Characteristics





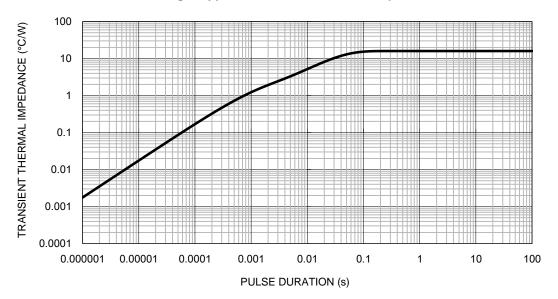
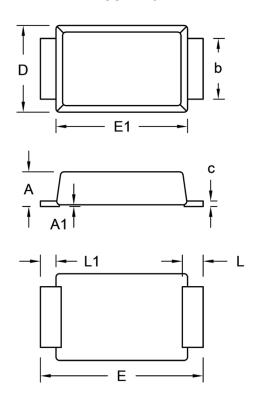


Fig.7 Typical Transient Thermal Impedance



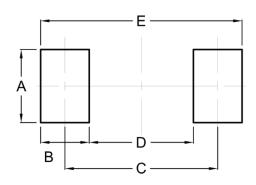
PACKAGE OUTLINE DIMENSIONS

SOD-128



| DIM. | Unit | (mm) | Unit (inch) | | |
|--------|------|------|-------------|-------|--|
| DIIVI. | Min. | Max. | Min. | Max. | |
| Α | 0.90 | 1.10 | 0.035 | 0.043 | |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 | |
| b | 1.60 | 1.90 | 0.063 | 0.075 | |
| С | 0.10 | 0.22 | 0.004 | 0.009 | |
| D | 2.30 | 2.70 | 0.091 | 0.106 | |
| E | 4.40 | 5.00 | 0.173 | 0.197 | |
| E1 | 3.60 | 4.00 | 0.142 | 0.157 | |
| L | 0.40 | 0.80 | 0.016 | 0.031 | |
| L1 | 0.30 | 0.60 | 0.012 | 0.024 | |

SUGGESTED PAD LAYOUT



| Symbol | Unit (mm) | Unit (inch) |
|--------|-----------|-------------|
| Α | 2.10 | 0.083 |
| В | 1.40 | 0.055 |
| С | 4.40 | 0.173 |
| D | 3.00 | 0.118 |
| E | 5.80 | 0.228 |

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code

5



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